



DMTH6010LPDQ

60V 175°C DUAL N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

PPAP and is ideal for use in:

DC-DC Converters

BV _{DSS}	R _{DS(ON)} max	I _D max T _C = +25°C
60V	11mΩ @ V _{GS} = 10V	47.6A
000	16mΩ @ V _{GS} = 4.5V	39.5A

This MOSFET is designed to meet the stringent requirements of

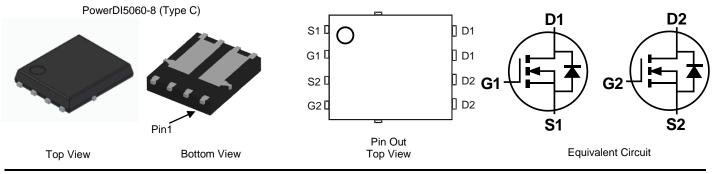
Automotive applications. It is qualified to AEC-Q101, supported by a

Features and Benefits

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching Ensures More Reliable and Robust End Application
- High Conversion Efficiency
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Mechanical Data

- Case: PowerDI5060-8
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 ⁽³⁾
- Weight: 0.097 grams (Approximate)



Ordering Information (Note 5)

Description and Applications

Engine Management Systems

Body Control Electronics

	Part Number	Case	Packaging			
	DMTH6010LPDQ-13	PowerDI5060-8 (Type C)	2,500/Tape & Reel			
Notes:	tes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.					

No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and

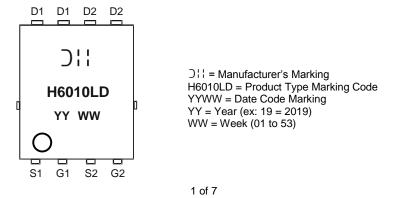
Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to https://www.diodes.com/quality/.

5. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information





Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Drain-Source Voltage	V _{DSS}	60	V	
Gate-Source Voltage	V _{GSS}	±20	V	
Continuous Drain Current (Note 7)	T _C = +25°C T _C = +100°C	ID	47.6 33.7	A
Continuous Drain Current (Note 6)	T _A = +25°C T _A = +70°C	ID	13.1 10.9	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	90	А	
Maximum Continuous Body Diode Forward Current (Note 7)	ls	31	А	
Avalanche Current, L = 0.1mH	I _{AS}	20	А	
Avalanche Energy, L = 0.1mH		E _{AS}	20	mJ

Thermal Characteristics

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 6)	T _A = +25°C	PD	2.8	W
Thermal Resistance, Junction to Ambient (Note 6)	R _{0JA}	53	°C/W	
Total Power Dissipation (Note 7)	PD	37.5	W	
Thermal Resistance, Junction to Case (Note 7)	R _{0JC}	4	°C/W	
Operating and Storage Temperature Range	T _{J,} T _{STG}	-55 to +175	°C	

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV _{DSS}	60	—		V	$V_{GS} = 0V, I_D = 1mA$	
Zero Gate Voltage Drain Current	I _{DSS}		_	1	μA	$V_{DS} = 48V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	—	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V _{GS(TH)}	1		3	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
Static Drain-Source On-Resistance	Provenu	_	8.5	11	mΩ	$V_{GS} = 10V, I_D = 20A$	
	R _{DS(ON)}	_	10.9	16	11152	$V_{GS} = 4.5V, I_D = 20A$	
Diode Forward Voltage	V _{SD}	—	0.9	1.2	V	$V_{GS} = 0V, I_{S} = 20A$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	C _{iss}	_	2615	_	pF		
Output Capacitance	Coss	—	1415	—	pF	$V_{DS} = 30V, V_{GS} = 0V,$ - f = 1MHz	
Reverse Transfer Capacitance	Crss	_	58	_	pF		
Gate Resistance	R _g	_	0.67	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	20.3	_	nC		
Total Gate Charge (V _{GS} = 10V)	Qg	—	40.2	_	nC		
Gate-Source Charge	Q _{gs}	_	5.9	_	nC	$V_{DS} = 30V, I_D = 20A$	
Gate-Drain Charge	Q _{gd}	_	9.3	_	nC	7	
Turn-On Delay Time	t _{D(ON)}	_	5.7	_	ns		
Turn-On Rise Time	t _R	_	8.8	_	ns	$V_{DD} = 30V, V_{GS} = 10V,$	
Turn-Off Delay Time	t _{D(OFF)}	_	20.8	_	ns	$I_D = 20A, R_G = 3\Omega$	
Turn-Off Fall Time	t _F	_	7.4	_	ns	7	
Body Diode Reverse Recovery Time	t _{RR}	_	34.5	_	ns		
Body Diode Reverse Recovery Charge	Q _{RR}	_	37.5	_	nC	I _F = 20A, di/dt = 100A/µs	

Notes: 6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

7. Thermal resistance from junction to soldering point (on the exposed drain pad).

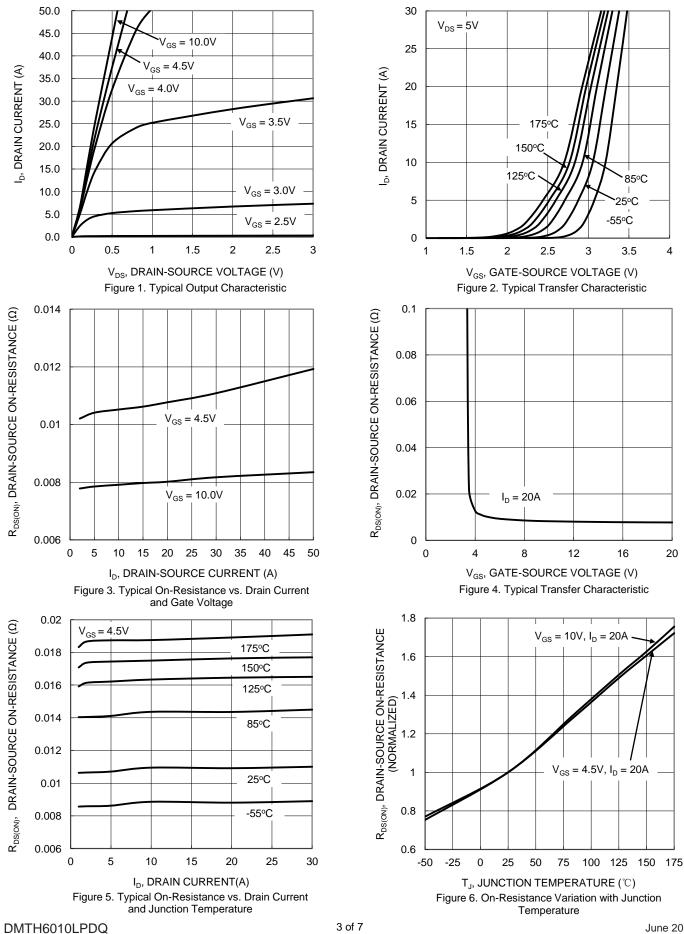
8. Short duration pulse test used to minimize self-heating effect.

9. Guaranteed by design. Not subject to product testing.



DMTH6010LPDQ

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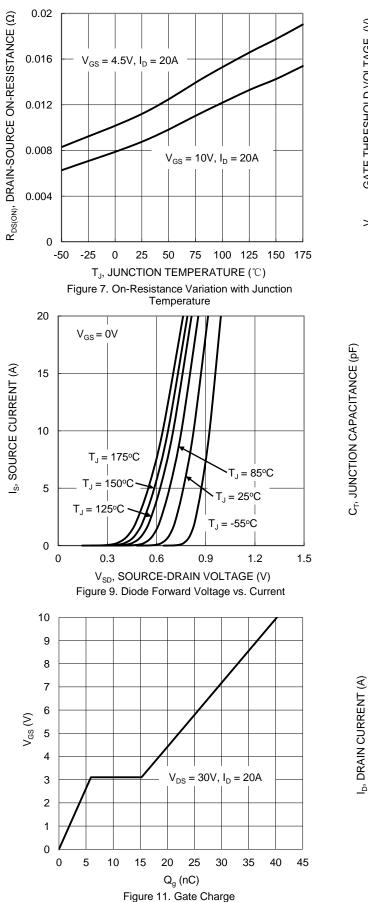
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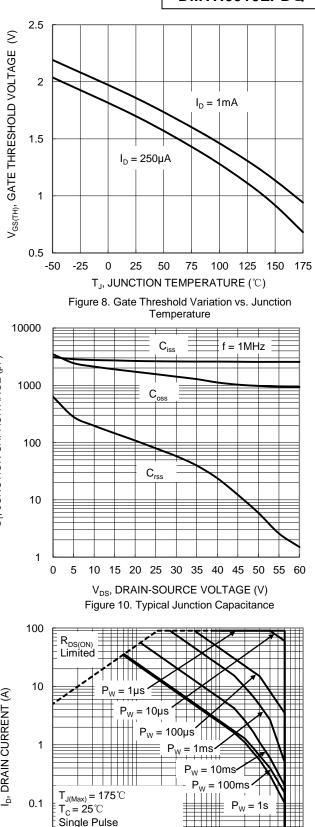
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DUT on Infinite Heatsink

 $V_{GS} = 10V$

0.01

0.1



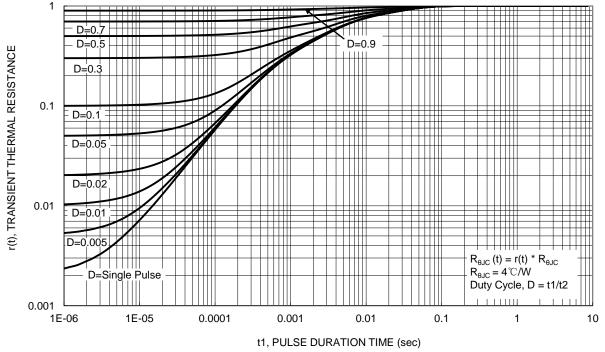


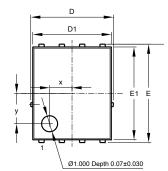
Figure 13. Transient Thermal Resistance

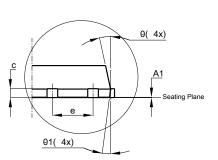


Package Outline Dimensions

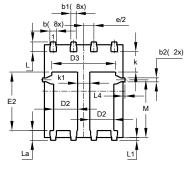
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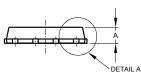
PowerDI5060-8 (Type C)







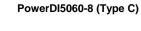


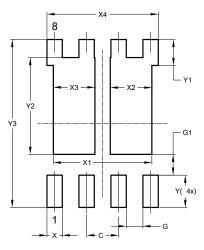


Pow	PowerDI5060-8 (Type C)					
Dim	Min	Max	Тур			
Α	0.90	1.10	1.00			
A1	0	0.05	0.02			
b	0.33	0.51	0.41			
b1	0.300	0.366	0.333			
b2	0.20	0.35	0.25			
С	0.23	0.33	0.277			
D	5	.15 BS0	0			
D1	4.85	4.95	4.90			
D2	1.40	1.60	1.50			
D3			3.98			
Е	6	6.15 BS0	0			
E1	5.75	5.85	5.80			
E2	3.56 3.76		3.66			
е	1	1.27BS0)			
k	-	-	1.27			
k1	0.56	-	-			
L	0.51	0.71	0.61			
La	0.51	0.71	0.61			
L1	0.05	0.20	0.175			
L4	-	-	0.125			
М	3.50 3.71 3		3.605			
х	-	-	1.400			
У	-	-	1.900			
θ	10°	12°	11°			
θ1	6°	8°	7°			
All	All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.





Dimensions	Value (in mm)			
С	1.270			
G	0.660			
G1	0.820			
Х	0.610			
X1	3.910			
X2	1.650			
X3	1.650			
X4	4.420			
Y	1.270			
Y1	1.020			
Y2	3.810			
Y3	6.610			



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